

# OV7670/OV7171 CMOS VGA (640x480) CAMERACHIP<sup>TM</sup> with OmniPixel<sup>®</sup> Technology

### **General Description**

The OV7670/OV7171 CAMERACHIP<sup>TM</sup> is a low voltage CMOS image sensor that provides the full functionality of a single-chip VGA camera and image processor in a small footprint package. The OV7670/OV7171 provides full-frame, sub-sampled or windowed 8-bit images in a wide range of formats, controlled through the Serial Camera Control Bus (SCCB) interface.

This product has an image array capable of operating at up to 30 frames per second (fps) in VGA with complete user control over image quality, formatting and output data transfer. All required image processing functions, including exposure control, gamma, white balance, color saturation, hue control and more, are also programmable through the SCCB interface. In addition, OmniVision CAMERACHIPS use proprietary sensor technology to improve image quality by reducing or eliminating common lighting/electrical sources of image contamination, such as fixed pattern noise (FPN), smearing, blooming, etc., to produce a clean, fully stable color image.



**Note:** The OV7670/OV7171 uses a lead-free package.

#### **Features**

- High sensitivity for low-light operation
- Low operating voltage for embedded portable apps
- Standard SCCB interface compatible with I2C interface.
- Supports VGA, CIF, and resolutions lower than CIF for RGB (GRB 4:2:2, RGB565/555), YUV (4:2:2) and YCbCr (4:2:2) formats
- VarioPixel<sup>®</sup> method for sub-sampling
- Automatic image control functions including: Automatic Exposure Control (AEC), Automatic Gain Control (AGC), Automatic White Balance (AWB), Automatic Band Filter (ABF), and Automatic Black-Level Calibration (ABLC)
- Image quality controls including color saturation, hue, gamma, sharpness (edge enhancement), and anti-blooming
- ISP includes noise reduction and defect correction
- · Supports LED and flash strobe mode
- Supports scaling
- · Lens shading correction
- Flicker (50/60 Hz) auto detection
- Saturation level auto adjust (UV adjust)
- Edge enhancement level auto adjust
- · De-noise level auto adjust

#### Ordering Information

Product	Package
OV07670-VL2A (Color, lead-free)	24 pin CSP2
OV07171-VL2A (B&W, lead-free)	24 pin CSP2

### **Applications**

- · Cellular and Picture Phones
- Tovs
- PC Multimedia
- Digital Still Cameras

### **Key Specifications**

Array E	lement (VGA)	640 x 480
	Digital Core	1.8VDC <u>+</u> 10%
Power Supply	Analog	2.45V to 3.0V
	I/O	1.7V to 3.0V
Power	Active	TBD
Requirements	Standby	< 20 µA
Temperature	Operation	-30°C to 70°C
Range	Stable Image	0°C to 50°C
Output F	Formats (8-bit)	<ul><li>YUV/YCbCr 4:2:2</li><li>RGB565/555</li><li>GRB 4:2:2</li><li>Raw RGB Data</li></ul>
7	Lens Size	1/6"
	nief Ray Angle	24°
Ma	ximum Image Transfer Rate	30 fps for VGA
	Sensitivity	1.1 V/Lux-sec
	S/N Ratio	40 dB
D	ynamic Range	TBD
	Scan Mode	Progressive
Electro	nics Exposure	Up to 510:1 (for selected fps)
	Pixel Size	3.6 μm x 3.6 μm
	Dark Current	12 mV/s at 60°C
	Well Capacity	17 K e
	Image Area	2.36 mm x 1.76 mm
Packag	e Dimensions	3785 μm x 4235 μm

Figure 1 OV7670/OV7171 Pin Diagram (Top View)

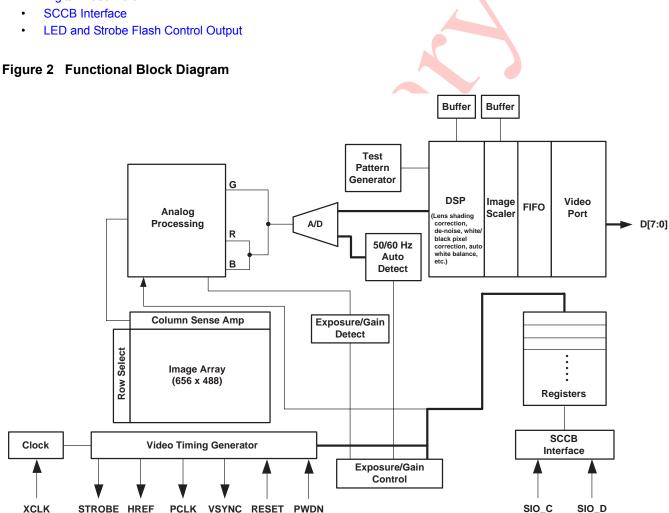
A1 AVDD B1 PWDN	SIO_D B2 VREF2	A3 SIO_C B3 AGND	A4 D1 B4 D0	A5 D3 B5 D2	
DVDD D1 VSYNC	C2 VREF1 D2 HREF	OV76	570/OV	7171	
E1 PCLK	STROBE	XCLK	D7	E5 D5	
DOVDD	(F2) RESET	DOGND	F4 D6	(F5) D4	



### **Functional Description**

Figure 2 shows the functional block diagram of the OV7670/OV7171 image sensor. The OV7670/OV7171 includes:

- Image Sensor Array (total array of 656 x 488 pixels, with active pixels 640 x 480 in YUV mode)
- **Analog Signal Processor**
- A/D Converters
- **Test Pattern Generator**
- Digital Signal Processor (DSP)
- Image Scaler
- **Timing Generator**
- Digital Video Port

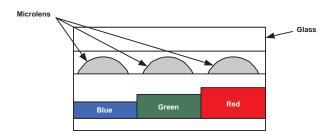




#### **Image Sensor Array**

The OV7670/OV7171 sensor has an image array of 656 x 488 pixels for a total of 320,128 pixels, of which 640 x 480 pixels are active (307,200 pixels). Figure 3 shows a cross-section of the image sensor array.

Figure 3 Image Sensor Array



#### **Timing Generator**

In general, the timing generator controls the following functions:

- · Array control and frame generation
- · Internal timing signal generation and distribution
- Frame rate timing
- Automatic Exposure Control (AEC)
- External timing outputs (VSYNC, HREF/HSYNC, and PCLK)

### **Analog Signal Processor**

This block performs all analog image functions including:

- Automatic Gain Control (AGC)
- Automatic White Balance (AWB)

#### A/D Converters

After the Analog Processing block, the bayer pattern Raw signal is fed to a 10-bit analog-to-digital (A/D) converter shared by G and BR channels. This A/D converter operates at speeds up to 12 MHz and is fully synchronous to the pixel rate (actual conversion rate is related to the frame rate).

In addition to the A/D conversion, this block also has the following functions:

- Digital Black-Level Calibration (BLC)
- Optional U/V channel delay
- · Additional A/D range controls

In general, the combination of the A/D Range Multiplier and A/D Range Control sets the A/D range and maximum value to allow the user to adjust the final image brightness as a function of the individual application.

#### **Test Pattern Generator**

The Test Pattern Generator features the following:

- 8-bar color bar pattern
- Fade-to-gray color bar pattern
- Shift "1" in output pin

#### **Digital Signal Processor (DSP)**

This block controls the interpolation from Raw data to RGB and some image quality control.

- Edge enhancement (a two-dimensional high pass filter)
- Color space converter (can change Raw data to RGB or YUV/YCbCr)
- RGB matrix to eliminate color cross talk
- Hue and saturation control
- White/black pixel correction
- De-noise
- Lens shading correction
- Programmable gamma control
- Transfer 10-bit data to 8-bit

#### Image Scaler

This block controls all output and data formatting required prior to sending the image out. This block scales YUV/RGB output from VGA to CIF and almost any size under CIF.

#### **Digital Video Port**

Register bits COM2[1:0] increase  $I_{OL}/I_{OH}$  drive current and can be adjusted as a function of the customer's loading.

#### **SCCB Interface**

The Serial Camera Control Bus (SCCB) interface controls the CAMERACHIP operation. Refer to *OmniVision Technologies Serial Camera Control Bus (SCCB) Specification* for detailed usage of the serial control port.

#### **LED and Strobe Flash Control Output**

The OV7670/OV7171 has a Strobe mode that allows it to work with an external flash and LED.



# **Pin Description**

Table 1 Pin Description

Pin Number	Name	Pin Type	Function/Description
A1	AVDD	Power	Analog power supply
A2	SIO_D	I/O	SCCB serial interface data I/O
A3	SIO_C	Input	SCCB serial interface clock input
A4	D1 <sup>a</sup>	Output	YUV/RGB video component output bit[1]
A5	D3	Output	YUV/RGB video component output bit[3]
B1	PWDN	Input (0) <sup>b</sup>	Power Down Mode Selection 0: Normal mode 1: Power down mode
B2	VREF2	Reference	Reference voltage - connect to ground using a 0.1 µF capacitor
В3	AGND	Power	Analog ground
B4	D0	Output	YUV/RGB video component output bit[0]
B5	D2	Output	YUV/RGB video component output bit[2]
C1	DVDD	Power	Power supply (+1.8 VDC) for digital logic core
C2	VREF1	Reference	Reference voltage - connect to ground using a 0.1 µF capacitor
D1	VSYNC	Output	Vertical sync output
D2	HREF	Output	HREF output
E1	PCLK	Output	Pixel clock output
E2	STROBE	Output	LED/strobe control output
E3	XCLK	Input	System clock input
E4	D7	Output	YUV/RGB video component output bit[7]
E5	D5	Output	YUV/RGB video component output bit[5]
F1	DOVDD	Power	Digital power supply for I/O (1.7V ~ 3.0V)
F2	RESET	Input (0)	Clears all registers and resets them to their default values.  0: Normal mode  1: Reset mode
F3	DOGND	Power	Digital ground
F4	D6	Output	YUV/RGB video component output bit[6]
F5	D4	Output	YUV/RGB video component output bit[4]

a. D[7:0] for 8-bit YUV or RGB (D[7] MSB, D[0] LSB)

b. Input (0) represents an internal pull-down resistor.



### **Electrical Characteristics**

Table 2 Absolute Maximum Ratings

Ambient Storage Temperature	-40°C to +95°C	
	V <sub>DD-A</sub>	4.5 V
Supply Voltages (with respect to Ground)	V <sub>DD-C</sub>	3 V
	$V_{DD-IO}$	4.5 V
All Input/Output Voltages (with respect to Ground)	-0.3V to V <sub>DD-IO</sub> +0.5V	
Lead-free Temperature, Surface-mount process	245°C	
ESD Rating, Human Body model	2000V	

**NOTE:** Exceeding the Absolute Maximum ratings shown above invalidates all AC and DC electrical specifications and may result in permanent device damage.

Table 3 DC Characteristics (-30°C <  $T_A$  < 70°C)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
V <sub>DD-A</sub>	DC supply voltage – Analog	-	2.45	2.75	3.0	V
V <sub>DD-C</sub>	DC supply voltage – Digital Core	-	1.62	1.8	1.98	V
V <sub>DD-IO</sub>	DC supply voltage – I/O power	-	1.7	-	3.0V	V
I <sub>DDA</sub>	Active (Operating) Current	See Note <sup>a</sup>		10 + 8 <sup>b</sup>		mA
I <sub>DDS-SCCB</sub>	Standby Current	See Note <sup>c</sup>		1		mA
I <sub>DDS-PWDN</sub>	Standby Current	See Note		10	20	μΑ
V <sub>IH</sub>	Input voltage HIGH	CMOS	0.7 x V <sub>DD-IO</sub>			V
V <sub>IL</sub>	Input voltage LOW				0.3 x V <sub>DD-IO</sub>	V
V <sub>OH</sub>	Output voltage HIGH	CMOS	0.9 x V <sub>DD-IO</sub>			V
V <sub>OL</sub>	Output voltage LOW				0.1 x V <sub>DD-IO</sub>	V
Гон	Output current HIGH	See Note <sup>d</sup>	8			mA
I <sub>OL</sub>	Output current LOW		15			mA
IL	Input/Output Leakage	GND to V <sub>DD-IO</sub>			± 1	μΑ

a.  $V_{DD-A}$  = 2.5V,  $V_{DD-C}$  = 1.8V,  $V_{DD-IO}$  = 2.5V  $I_{DDA}$  =  $\sum \{I_{DD-IO} + I_{DD-C} + I_{DD-A}\}$ ,  $f_{CLK}$  = 24MHz at 30 fps YUV output, no I/O loading

b.  $I_{DD-C} = 10mA$ ,  $I_{DD-A} = 8mA$ , without loading

c.  $V_{DD-A} = 2.5V$ ,  $V_{DD-C} = 1.8V$ ,  $V_{DD-IO} = 2.5V$ 

 $I_{DDS\text{-}SCCB} \text{ refers to a SCCB-initiated Standby, while } I_{DDS\text{-}PWDN} \text{ refers to a PWDN pin-initiated Standby}$ 

d. Standard Output Loading = 25pF,  $1.2K\Omega$ 



Table 4 Functional and AC Characteristics (-30°C <  $T_A$  < 70°C)

Symbol	Parameter	Min	Тур	Max	Unit
Functional C	haracteristics				
	A/D Differential Non-Linearity		<u>+</u> 1/2		LSB
	A/D Integral Non-Linearity		<u>+</u> 1		LSB
	AGC Range			30	dB
(D)((D)	Red/Blue Adjustment Range			12	dB
	N, CLK, RESET)	40	0.4	40	
f <sub>CLK</sub>	Input Clock Frequency	10	24	48	MHz
t <sub>CLK</sub>	Input Clock Period	21	42	100	ns
t <sub>CLK:DC</sub>	Clock Duty Cycle	45	50	55	%
t <sub>S:RESET</sub>	Setting time after software/hardware reset			1	ms
t <sub>S:REG</sub>	Settling time for register change (10 frames required)			300	ms
SCCB Timing	g (see Figure 4)				
f <sub>SIO_C</sub>	Clock Frequency			400	KHz
t <sub>LOW</sub>	Clock Low Period	1.3			μS
t <sub>HIGH</sub>	Clock High Period	600			ns
t <sub>AA</sub>	SIO_C low to Data Out valid	100		900	ns
t <sub>BUF</sub>	Bus free time before new START	1.3			μS
t <sub>HD:STA</sub>	START condition Hold time	600			ns
t <sub>SU:STA</sub>	START condition Setup time	600			ns
t <sub>HD:DAT</sub>	Data-in Hold time	0			μS
t <sub>SU:DAT</sub>	Data-in Setup time	100			ns
t <sub>SU:STO</sub>	STOP condition Setup time	600			ns
t <sub>R,</sub> t <sub>F</sub>	SCCB Rise/Fall times			300	ns
t <sub>DH</sub>	Data-out Hold time	50			ns
Outputs (VS)	/NC, HREF, PCLK, and D[7:0] (see Figure 5, Figure 6, F	igure 7, Figu	re 9, and F	igure 10)	
t <sub>PDV</sub>	PCLK[↓] to Data-out Valid			5	ns
t <sub>SU</sub>	D[7:0] Setup time	15			ns
t <sub>HD</sub>	D[7:0] Hold time	8			ns
t <sub>PHH</sub>	PCLK[↓] to HREF[↑]	0		5	ns
t <sub>PHL</sub>	PCLK[↓] to HREF[↓]	0		5	ns
AC Conditions:	<ul> <li>V<sub>DD</sub>: V<sub>DD-C</sub> = 1.8V, V<sub>DD-A</sub> = 2.5V, V<sub>DD-IO</sub> = 2.5V</li> <li>Rise/Fall Times: I/O: 5ns, Maximum SCCB: 300ns, Maximum</li> <li>Input Capacitance: 10pf</li> <li>Output Loading: 25pF, 1.2KΩ to 2.5V</li> <li>f<sub>CLK</sub>: 24MHz</li> </ul>				



### **Timing Specifications**

### Figure 4 SCCB Timing Diagram

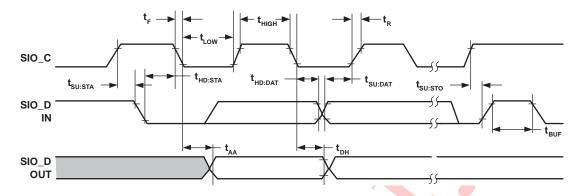


Figure 5 Horizontal Timing

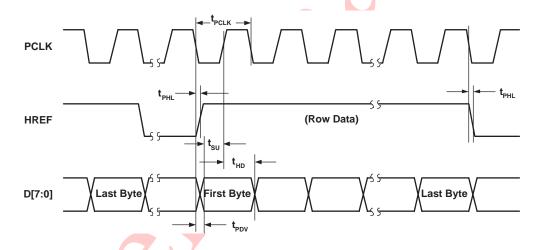
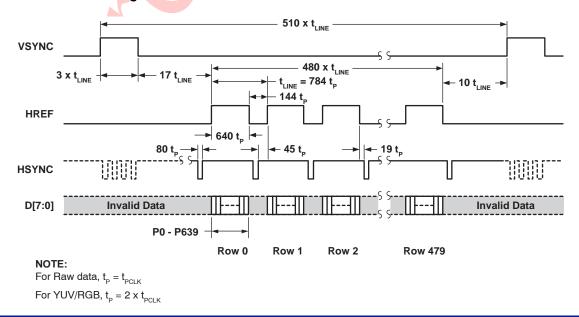
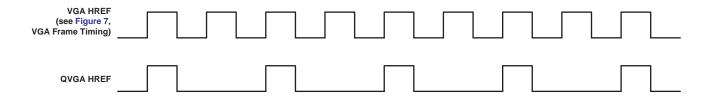


Figure 6 VGA Frame Timing

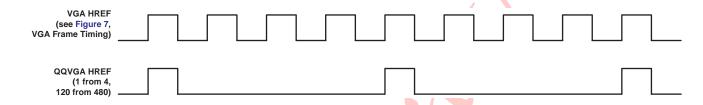




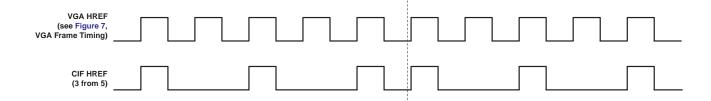
## Figure 7 QVGA Frame Timing



### Figure 8 QQVGA Frame Timing



## Figure 9 CIF Frame Timing



### Figure 10 QCIF Frame Timing

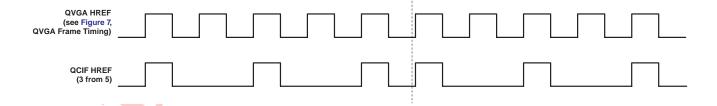




Figure 11 RGB 565 Output Timing Diagram

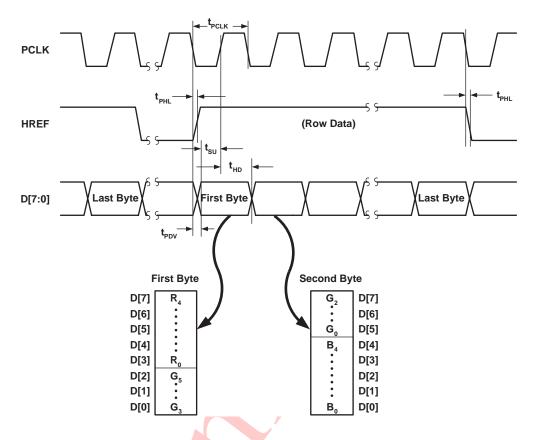
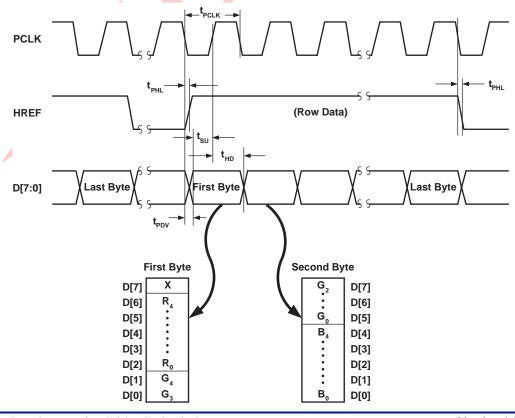


Figure 12 RGB 555 Output Timing Diagram





### **Register Set**

Table 5 provides a list and description of the Device Control registers contained in the OV7670/OV7171. For all register Enable/Disable bits, ENABLE = 1 and DISABLE = 0. The device slave addresses are 42 for write and 43 for read.

Table 5 Device Control Register List

Address (Hex)	Register Name	Default (Hex)	R/W	Description
00	GAIN	00	RW	AGC – Gain control gain setting  Bit[7:0]: AGC[7:0] (see VREF[7:6] (0x03) for AGC[9:8])  • Range: [00] to [FF]
01	BLUE	80	RW	AWB – Blue channel gain setting • Range: [00] to [FF]
02	RED	80	RW	AWB – Red channel gain setting • Range: [00] to [FF]
03	VREF	03	RW	Vertical Frame Control  Bit[7:6]: AGC[9:8] (see GAIN[7:0] (0x00) for AGC[7:0])  Bit[5:4]: Reserved  Bit[3:2]: VREF end low 2 bits (high 8 bits at VSTOP[7:0]  Bit[1:0]: VREF start low 2 bits (high 8 bits at VSTRT[7:0]
04	COM1	00	RW	Common Control 1  Bit[7]: Reserved  Bit[6]: CCIR656 format  0: Disable  1: Enable  Bit[5:2]: Reserved  Bit[1:0]: AEC low 2 LSB (see registers AECHH for AEC[15:10] and AECH for AEC[9:2])
05	BAVE	00	RW	U/B Average Level Automatically updated based on chip output format
06	GbAVE	00	RW	Y/Gb Average Level Automatically updated based on chip output format
07	АЕСНН	00	RW	Exposure Value - AEC MSB 5 bits  Bit[7:6]: Reserved  Bit[5:0]: AEC[15:10] (see registers AECH for AEC[9:2] and COM1 for AEC[1:0])
08	RAVE	00	RW	V/R Average Level Automatically updated based on chip output format
09	COM2	01	RW	Common Control 2  Bit[7:5]: Reserved  Bit[4]: Soft sleep mode  Bit[3:2]: Reserved  Bit[1:0]: Output Drive Capability  00: 1x  01: 2x  10: 3x  11: 4x



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
0A	PID	76	R	Product ID Number MSB (Read only)
0B	VER	70	R	Product ID Number LSB (Read only)
0C	СОМЗ	00	RW	Bit[7]: Reserved Bit[6]: Output data MSB and LSB swap Bit[5]: Tri-state option for output clock at power-down period 0: Tri-state at this period 1: No tri-state at this period Bit[4]: Tri-state option for output data at power-down period 0: Tri-state at this period 1: No tri-state at this period 1: No tri-state at this period Bit[3]: Scale enable 0: Disable 1: Enable - if set to a pre-defined format (see
OD	COM4	40	RW	Common Control 4  Bit[7:6]: Reserved  Bit[5:4]: Average option (must be same value as COM17[7:6])  00: Full window  01: 1/2 window  10: 1/4 window  11: 1/4 window  Bit[3:0]: Reserved
0E	COM5	01	RW	Common Control 5 Bit[7:0]: Reserved
OF	COM6	43	RW	Common Control 6  Bit[7]: Output of optical black line option  0: Disable HREF at optical black  1: Enable HREF at optical black  Bit[6]: BLC input selection  0: Use electrical black line as BLC signal  1: Use optical black line as BLC signal  Bit[5]: Digital BLC enable  Bit[4:2]: Reserved  Bit[1]: Reset all timing when format changes  Bit[0]: Reserved
10	AECH	40	RW	Exposure Value  Bit[7:0]: AEC[9:2] (see registers AECHH for AEC[15:10] and COM1 for AEC[1:0])



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
11	CLKRC	80	RW	Internal Clock  Bit[7]: Digital PLL option  0: Disable double clock option, meaning the maximum PCLK can be as high as half input clock  1: Enable double clock option, meaning the maximum PCLK can be as high as input clock  Bit[6]: Use external clock directly (no clock pre-scale available)  Bit[5:0]: Internal clock pre-scalar  F(internal clock) = F(input clock)/(Bit[5:0]+1)  Range: [0 0000] to [1 1111]
12	COM7	00	RW	Common Control 7  Bit[7]: SCCB Register Reset  0: No change 1: Resets all registers to default values  Bit[6]: Reserved  Bit[5]: Output format - CIF selection  Bit[4]: Output format - QVGA selection  Bit[3]: Output format - QCIF selection  Bit[2]: Output format - RGB selection (see below)  Bit[1]: Color bar  0: Disable  1: Enable  Bit[0]: Output format - Raw RGB (see below)  COM7[2] COM7[0]  YUV  0  0  COM7[2] COM7[0]  YUV  0  1  Bayer RAW  0  1  Processed Bayer RAW  1
13	COM8	8F	RW	Common Control 8  Bit[7]: Enable fast AGC/AEC algorithm  Bit[6]: AEC - Step size limit  0: Step size is limited to vertical blank  1: Unlimited step size  Bit[5]: Banding filter ON/OFF - In order to turn ON the banding filter, BD50ST (0x9D) or BD60ST (0x9E) must be set to a non-zero value.  0: ON  1: OFF  Bit[4:3]: Reserved  Bit[2]: AGC Enable  Bit[1]: AWB Enable  Bit[0]: AEC Enable



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
14	СОМ9	4A	RW	Common Control 9  Bit[7]: Reserved  Bit[6:4]: Automatic Gain Ceiling - maximum AGC value  000: 2x  001: 4x  010 8x  011: 16x  100: 32x  101 64x  110: 128x  111: Not allowed  Bit[3:1]: Reserved  Bit[0]: Freeze AGC/AEC
15	COM10	00	RW	Common Control 10  Bit[7]: Reserved  Bit[6]: HREF changes to HSYNC  Bit[5]: PCLK output option  0: Free running PCLK  1: PCLK does not toggle during horizontal blank  Bit[4]: PCLK reverse  Bit[3]: HREF reverse  Bit[2]: VSYNC option  0: VSYNC changes on falling edge of PCLK  1: VSYNC changes on rising edge of PCLK  Bit[1]: VSYNC negative  Bit[0]: HSYNC negative
16	RSVD	XX	-	Reserved
17	HSTART	11	RW	Output Format - Horizontal Frame (HREF column) start high 8-bit (low 3 bits are at HREF[2:0])
18	HSTOP	61	RW	Output Format - Horizontal Frame (HREF column) end high 8-bit (low 3 bits are at HREF[5:3])
19	VSTRT	03	RW	Output Format - Vertical Frame (row) start high 8-bit (low 2 bits are at VREF[1:0])
1A	VSTOP	7B	RW	Output Format - Vertical Frame (row) end high 8-bit (low 2 bits are at VREF[3:2])
1B	PSHFT	00	RW	Data Format - Pixel Delay Select (delays timing of the D[7:0] data relative to HREF in pixel units)  • Range: [00] (no delay) to [FF] (256 pixel delay which accounts for whole array)
1C	MIDH	7F	R	Manufacturer ID Byte – High (Read only = 0x7F)
1D	MIDL	A2	R	Manufacturer ID Byte – Low (Read only = 0xA2)



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
1E	MVFP	00	RW	Mirror/VFlip Enable  Bit[7:6]: Reserved  Bit[5]: Mirror  0: Normal image 1: Mirror image  Bit[4]: VFlip enable 0: Normal image 1: Vertically flip image  Bit[3]: Reserved  Bit[2]: Black sun enable  Bit[1:0]: Reserved
1F	LAEC	00	RW	Reserved
20	ADCCTR0	04	RW	ADC Control  Bit[7:4]: Reserved  Bit[3]: ADC range adjustment  0: 1x range  1: 1.5x range  Bit[2:0]: ADC reference adjustment  000: 0.8x  100: 1x  111: 1.2x
21	ADCCTR1	02	RW	Bit[7:0]: Reserved
22	ADCCTR2	01	RW	Bit[7:0]: Reserved
23	ADCCTR3	80	RW	Bit[7:0]: Reserved
24	AEW	75	RW	AGC/AEC - Stable Operating Region (Upper Limit)
25	AEB	63	RW	AGC/AEC - Stable Operating Region (Lower Limit)
26	VPT	D4	RW	AGC/AEC Fast Mode Operating Region  Bit[7:4]: High nibble of upper limit of fast mode control zone  Bit[3:0]: High nibble of lower limit of fast mode control zone
27	BBIAS	80	RW	B Channel Signal Output Bias (effective only when COM6[3] = 1)  Bit[7]: Bias adjustment sign  0: Add bias  1: Subtract bias  Bit[6:0]: Bias value of 10-bit range
28	GbBIAS	80	RW	Gb Channel Signal Output Bias (effective only when COM6[3] = 1)  Bit[7]: Bias adjustment sign  0: Add bias  1: Subtract bias  Bit[6:0]: Bias value of 10-bit range
29	RSVD	XX	_	Reserved
2A	EXHCH	00	RW	Dummy Pixel Insert MSB  Bit[7:4]: 4 MSB for dummy pixel insert in horizontal direction  Bit[3:2]: HSYNC falling edge delay 2 MSB  Bit[1:0]: HSYNC rising edge delay 2 MSB



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description	
2B	EXHCL	00	RW	Dummy Pixel Insert LSB 8 LSB for dummy pixel insert in horizontal direction	
2C	RBIAS	80	RW	R Channel Signal Output Bias (effective only when COM6[3] = 1)  Bit[7]: Bias adjustment sign  0: Add bias  1: Subtract bias  Bit[6:0]: Bias value of 10-bit range	
2D	ADVFL	00	RW	LSB of insert dummy lines in vertical direction (1 bit equals 1 line)	
2E	ADVFH	00	RW	MSB of insert dummy lines in vertical direction	
2F	YAVE	00	RW	Y/G Channel Average Value	
30	HSYST	08	RW	HSYNC Rising Edge Delay (low 8 bits)	
31	HSYEN	30	RW	HSYNC Falling Edge Delay (low 8 bits)	
32	HREF	80	RW	HREF Control  Bit[7:6]: HREF edge offset to data output  Bit[5:3]: HREF end 3 LSB (high 8 MSB at register HSTOP)  Bit[2:0]: HREF start 3 LSB (high 8 MSB at register HSTART)	
33	CHLF	08	RW	Array Current Control Bit[7:0]: Reserved	
34	ARBLM	03	RW Array Reference Control Bit[7:0]: Reserved		
35-36	RSVD	XX	_	Reserved	
37	ADC	04	RW	ADC Control Bit[7:0]: Reserved	
38	ACOM	12	RW	ADC and Analog Common Mode Control Bit[7:0]: Reserved	
39	OFON	00	RW	ADC Offset Control Bit[7:0]: Reserved	
3A	TSLB	0C	RW	Line Buffer Test Option  Bit[7:6]: Reserved  Bit[5]: Negative image enable  0: Normal image 1: Negative image Bit[4]: UV output value 0: Use normal UV output 1: Use fixed UV value set in registers MANU and MANV as UV output instead of chip output  Bit[3]: Output sequence (use with register COM13[1] (0x3D))  TSLB[3], COM13[1]:  00: Y U Y V 01: Y V Y U 10: U Y V Y 11: V Y U Y  Bit[2:0]: Reserved	



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
			R/W	Common Control 11  Bit[7]: Night mode  0: Night mode enable - The frame rate is reduced automatically while the minimum frame rate is limited by COM11[6:5]. Also, ADVFH and ADVFL will be automatically updated.  Bit[6:5]: Minimum frame rate of night mode  00: Same as normal mode frame rate  01: 1/2 of normal mode frame rate  10: 1/4 of normal mode frame rate  11: 1/8 of normal mode frame rate  11: 1/8 of normal mode frame rate  Bit[4]: D56_Auto  0: Disable 50/60 Hz auto detection  1: Enable 50/60 Hz auto detection  Bit[3]: Banding filter value select (effective only when COM11[4] = 0)  0: Select BD60ST[7:0] (0x9E) as Banding Filter Value  Bit[2]: Reserved  Bit[1]: Exposure timing can be less than limit of banding filter when light is too strong
3C	COM12	40	RW	Bit[0]: Reserved  Common Control 12  Bit[7]: HREF option  0: No HREF when VSYNC is low  1: Always has HREF  Bit[6:0]: Reserved
3D	COM13	99	RW	Common Control 13  Bit[7]: Gamma enable  Bit[6]: UV saturation level - UV auto adjustment. Result is saved in register SATCTR[3:0] (0xC9)  Bit[5:2]: Reserved  Bit[1]: UV swap (use with register TSLB[3] (0x3A))  TSLB[3], COM13[1]:  00: Y U Y V  01: Y V Y U  10: U Y V Y  Sit[0]: Reserved



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description	
3E	COM14	0E	RW	Common Control 14  Bit[7:5]: Reserved  Bit[4]: DCW and scaling PCLK enable  0: Normal PCLK  1: DCW and scaling PCLK, controlled by register COM14[2:0] and SCALING_PCLK_DIV[3:0] (0x73))  Bit[3]: Manual scaling enable for pre-defined resolution modes such as CIF, QCIF, and QVGA  0: Scaling parameter cannot be adjusted manually  1: Scaling parameter can be adjusted manually  Bit[2:0]: PCLK divider (only when COM14[4] = 1)  000: Divided by 1  001: Divided by 2  010 Divided by 4  011: Divided by 8  100: Divided by 16  101~111: Not allowed	
3F	EDGE	88	RW	Edge Enhancement Adjustment  Bit[7:5]: Reserved  Bit[4:0]: Edge enhancement factor	
40	COM15	CO	RW	Common Control 15  Bit[7:6]: Data format - output full range enable  0x: Output range: [10] to [F0]  10: Output range: [01] to [FE]  11: Output range: [00] to [FF]  Bit[5:4]: RGB 555/565 option (must set COM7[2] = 1 and COM7[0] = 0)  x0: Normal RGB output  01: RGB 565  11: RGB 555  Bit[3:0]: Reserved	



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description		
(1.07.)		(1211)		Common Control 16		
				Bit[7:6]: Reserved		
				Bit[5]: Enable edge enhancement threshold auto-adjustment for YUV output (result is saved in register EDGE[4:0] (0x3F) and range is controlled by registers REG75[4:0] (0x75) and REG76[4:0] (0x76))		
41	COM16	10	RW	0: Disable 1: Enable Bit[4]: De-noise threshold auto-adjustment (result is saved in register DNSTH (0x4C) and range is controlled by register REG77[7:0] (0x77))		
				0: Disable 1: Enable Bit[3]: AWB gain enable		
				Bit[2]: Reserved		
				Bit[1]: Color matrix coefficient double option  0: Original matrix		
				1: Double of original matrix		
				Bit[0]: Reserved		
				Common Control 17		
				Bit[7:6]: AEC window must be the same value as COM4[5:4])		
				00: Normal 01: 1/2		
			A	10: 1/4		
42	COM17	08	RW	11: 1/4		
				Bit[5:4]: Reserved  Bit[3]: DSP color bar enable		
				0: Disable		
				1: Enable		
			) ′	Bit[2:0]: Reserved		
43	AWBC1	14	RW	Reserved		
44	AWBC2	F0	RW	Reserved		
45	AWBC3	45	RW	Reserved		
46	AWBC4	61	RW	Reserved		
47	AWBC5	51	RW	Reserved		
48	AWBC6	79	RW	Reserved		
49-4A	RSVD	XX	-	Reserved		
40	DEC 4D	00	DW	Register 4B		
4B	REG4B	00	RW	Bit[7:1]: Reserved Bit[0]: UV average enable		
4C	DNSTH	00	RW	De-noise Threshold		
4D-4E	RSVD	XX	1	Reserved		
4F	MTX1	40	RW	Matrix Coefficient 1		
50	MTX2	34	RW	Matrix Coefficient 2		



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description	
51	MTX3	0C	RW	Matrix Coefficient 3	
52	MTX4	17	RW	Matrix Coefficient 4	
53	MTX5	29	RW	Matrix Coefficient 5	
54	MTX6	40	RW	Matrix Coefficient 6	
55	BRIGHT	00	RW	Brightness Control	
56	CONTRAS	40	RW	Contrast Control	
57	CONTRAS- CENTER	80	RW	Contrast Center	
58	MTXS	1E	RW	Matrix Coefficient Sign for coefficient 5 to 0  Bit[7]: Auto contrast center enable  0: Disable, center is set by register	
59-61	RSVD	XX	_	AWB Control	
62	LCC1	00	RW	Lens Correction Option 1	
63	LCC2	00	RW	Lens Correction Option 2	
64	LCC3	10	RW	Lens Correction Option 3	
65	LCC4	80	RW	Lens Correction Option 4	
66	LCC5	00	RW	Lens Correction Control  Bit[7:3]: Reserved  Bit[2]: Lens correction control select  Bit[1]: Reserved  Bit[0]: Lens correction enable	
67	MANU	80	RW	Manual U Value (effective only when register TSLB[4] is high)	
68	MANV	80	RW	Manual V Value (effective only when register TSLB[4] is high)	



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
69	GFIX	00	RW	Fix Gain Control  Bit[7:6]: Fix gain for Gr channel  00: 1x  01: 1.25x  10: 1.5x  11: 1.75x  Bit[5:4]: Fix gain for Gb channel  00: 1x  01: 1.25x  10: 1.5x  11: 1.75x  Bit[3:2]: Fix gain for R channel  00: 1x  01: 1.25x  10: 1.5x  11: 1.75x  Bit[1:0]: Fix gain for B channel  00: 1x  01: 1.5x  11: 1.75x  Bit[1:0]: Fix gain for B channel  00: 1x  01: 1.5x  11: 1.75x
6A	GGAIN	00	RW	G Channel AWB Gain
6B	DBLV	3A	RW	Bit[7:6]: PLL control  00: Bypass PLL  01: Input clock x4  10: Input clock x8  11: Input clock x16  Bit[5]: Reserved  Bit[4]: Regulator control  0: Enable internal regulator  1: Bypass internal regulator  Bit[3:0]: Clock divider control for DSP scale control (valid only when COM14[3] = 1)
6C	AWBCTR3	02	RW	AWB Control 3
6D	AWBCTR2	55	RW	AWB Control 2
6E	AWBCTR1	00	RW	AWB Control 1
6F	AWBCTR0	9A	RW	AWB Control 0
70	SCALING_ XSC	4A	RW	Bit[7]: Test_pattern[0] - works with test_pattern[1] test_pattern (SCALING_XSC[7], SCALING_YSC[7]): 00: No test output 01: Shifting "1" 10: 8-bar color bar 11: Fade to gray color bar Bit[6:0]: Horizontal scale factor

Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description
71	SCALING_ YSC	35	RW	Bit[7]: Test_pattern[1] - works with test_pattern[0] test_pattern (SCALING_XSC[7], SCALING_YSC[7]):: 00: No test output 01: Shifting "1" 10: 8-bar color bar 11: Fade to gray color bar Bit[6:0]: Vertical scale factor
72	SCALING_ DCWCTR	11	RW	DCW Control  Bit[7:0]: DCW control parameter
73	SCALING PCLK_DIV	00	RW	Bit[7:4]: Reserved Bit[3:0]: Clock divider control for DSP scale control (valid only when COM14[3] = 1). Should change with COM14[2:0].  0000: Divided by 1 0001: Divided by 2 0010: Divided by 4 0011: Divided by 8 0100: Divided by 16 0101~1111: Not allowed
74	REG74	00	RW	Bit[7:5]: Reserved Bit[4]: DG_Manu 0: Digital gain control by VREF[7:6] 1: Digital gain control by REG74[1:0] Bit[3:2]: Reserved Bit[1:0]: Digital gain manual control 00: Bypass 01: 1x 10: 2x 11: 4x
75	REG75	0F	RW	Register 75 Bit[7:5]: Reserved Bit[4:0]: Edge enhancement lower limit
76	REG76	01	RW	Register 76  Bit[7]: Reserved  Bit[6]: White pixel correction enable  0: Disable  1: Enable  Bit[5]: Black pixel correction enable  0: Disable  1: Enable  Bit[4:0]: Edge enhancement higher limit
77	REG77	10	RW	Register 77 Bit[7:0]: Offset, de-noise range control
78-79	RSVD	XX	_	Reserved
7A	GAM1	02	RW	Gamma Curve 1st Segment Input End Point 0x010 Output Value
7B	GAM2	07	RW	Gamma Curve 2nd Segment Input End Point 0x020 Output Value
7C	GAM3	1F	RW	Gamma Curve 3rd Segment Input End Point 0x040 Output Value



Table 5 Device Control Register List (Continued)

Address (Hex)	Register Name	Default (Hex)	R/W	Description	
7D	GAM4	49	RW	Gamma Curve 4th Segment Input End Point 0x080 Output Value	
7E	GAM5	5A	RW	Gamma Curve 5th Segment Input End Point 0x0A0 Output Value	
7F	GAM6	6A	RW	Gamma Curve 6th Segment Input End Point 0x0C0 Output Value	
80	GAM7	79	RW	Gamma Curve 7th Segment Input End Point 0x0E0 Output Value	
89	GAM8	87	RW	Gamma Curve 8th Segment Input End Point 0x100 Output Value	
89	GAM9	94	RW	Gamma Curve 9th Segment Input End Point 0x120 Output Value	
89	GAM10	9F	RW	Gamma Curve 10th Segment Input End Point 0x140 Output Value	
89	GAM11	AF	RW	Gamma Curve 11th Segment Input End Point 0x180 Output Value	
86	GAM12	BB	RW	Gamma Curve 12th Segment Input End Point 0x1C0 Output Value	
87	GAM13	CF	RW	Gamma Curve 13th Segment Input End Point 0x240 Output Value	
88	GAM14	EE	RW	Gamma Curve 14th Segment Input End Point 0x2C0 Output Value	
89	GAM15	EE	RW	Gamma Curve 15th Segment Input End Point 0x340 Output Value	
8A-91	RSVD	XX	_	Reserved	
92	DM_LNL	00	RW	Dummy Line low 8 bits	
93	DM_LNH	00	RW	Dummy Line high 8 bits	
94	LCC6	50	RW	Lens Correction Option 6 (effective only when LCC5[2] is high)	
95	LCC7	50	RW	Lens Correction Option 7 (effective only when LCC5[2] is high)	
96-9C	RSVD	XX	-/	Reserved	
9D	BD50ST	99	RW	50 Hz Banding Filter Value (effective only when COM8[5] is high and COM11[3] is high)	
9E	BD60ST	7F	RW	60 Hz Banding Filter Value (effective only when COM8[5] is high and COM11[3] is low)	
9F-AB		XX		Histogram-based AEC/AGC Control	
AC	STR-OPT	00	RW	Register AC  Bit[7]: Strobe enable  Bit[6]: R / G / B gain controlled by STR_R (0xAD) / STR_G (0xAE) / STR_B (0xAF) for LED output frame  Bit[5:4]: Xenon mode option  00: 1 line  01: 2 lines  10: 3 lines  11: 4 lines  Bit[3:2]: Reserved  Bit[1:0]: Mode select  00: Xenon  01: LED 1&2  1x: LED 3	
AD	STR_R	80	RW	R Gain for LED Output Frame	
AE	STR_G	80	RW	G Gain for LED Output Frame	



Table 5 **Device Control Register List (Continued)** 

Address (Hex)	Register Name	Default (Hex)	R/W	Description
B0-B2	RSVD	XX	-	Reserved
В3	THL_ST	80	RW	Digital BLC Target
B4	RSVD	XX	_	Reserved
B5	THL_DLT	04	RW	Digital BLC Stable Range
B6-BD	RSVD	XX	_	Reserved
BE	AD-CHB	00	RW	Bit[7]: Reserved Bit[6]: Sign bit Bit[5:0]: ADC offset value
BF	AD-CHR	00	RW	Bit[7]: Reserved Bit[6]: Sign bit Bit[5:0]: ADC offset value
C0	AD-CHGb	00	RW	Bit[7]: Reserved Bit[6]: Sign bit Bit[5:0]: ADC offset value
C1	AD-CHGr	00	RW	Bit[7]: Reserved Bit[6]: Sign bit Bit[5:0]: ADC offset value
C2-C8	RSVD	XX	-	Reserved
C9	SATCTR	CO	RW	Saturation Control  Bit[7:4]: UV saturation control min  Bit[3:0]: UV saturation control result

**NOTE:** All other registers are factory-reserved. Please contact OmniVision Technologies for reference register settings.



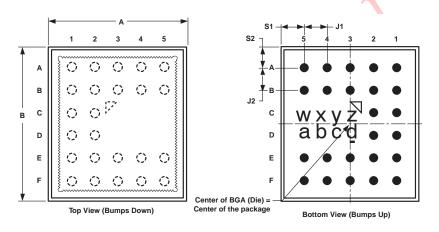
### **Package Specifications**

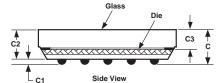
The OV7670/OV7171 uses a 24-ball Chip Scale Package 2 (CSP2). Refer to Figure 13 for package information, Table 6 for package dimensions and Figure 14 for the array center on the chip.



**Note:** For OVT devices that are lead-free, all part marking letters are lower case. Underlining the last digit of the lot number indicates CSP2 is used.

Figure 13 OV7670/OV7171 Package Specifications





Part Marking Code:

w - OVT Product Version
x - Year the part is assembled
y - Month the part is assembled

z - Wafer number

abcd - Last four digits of lot number

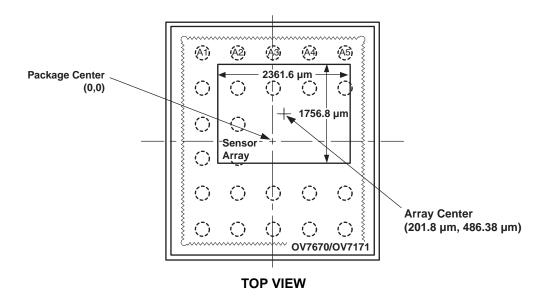
Table 6 OV7670/OV7171 Package Dimensions

Parameter	Symbol	Minimum	Nominal	Maximum	Unit
Package Body Dimension X	Α	3760	3785	3810	μm
Package Body Dimension Y	В	4210	4235	4260	μm
Package Height	С	825	885	945	μm
Ball Height	C1	130	160	190	μm
Package Body Thickness	C2	680	725	770	μm
Thickness of Glass Surface to Wafer	C3	425	445	465	μm
Ball Diameter	D	270	300	330	μm
Total Pin Count	N		24		
Pin Count X-axis	N1		5		
Pin Count Y-axis	N2		6		
Pins Pitch X-axis	J1		620		μm
Pins Pitch Y-axis	J2		620		μm
Edge-to-Pin Center Distance Analog X	S1	623	653	683	μm
Edge-to-Pin Center Distance Analog Y	S2	538	568	598	μm



### **Sensor Array Center**

Figure 14 OV7670/OV7171 Sensor Array Center



NOTES: 1. This drawing is not to scale and is for reference only.

2. As most optical assemblies invert and mirror the image, the chip is typically mounted with pins A1 to A5 oriented down on the PCB.





## **IR Reflow Ramp Rate Requirements**

### OV7670/OV7171 Lead-Free Packaged Devices



**Note:** For OVT devices that are lead-free, all part marking letters are lower case

Figure 15 IR Reflow Ramp Rate Requirements

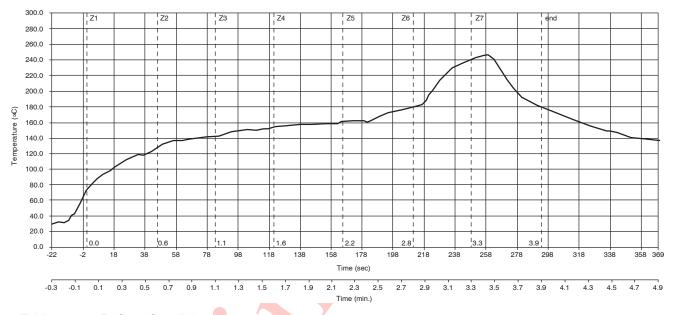


Table 7 Reflow Conditions

Condition	Exposure
Average Ramp-up Rate (30°C to 217°C)	Less than 3°C per second
> 100°C	Between 330 - 600 seconds
> 150°C	At least 210 seconds
> 217°C	At least 30 seconds (30 ~ 120 seconds)
Peak Temperature	245°C
Cool-down Rate (Peak to 50°C)	Less than 6°C per second
Time from 30°C to 255°C	No greater than 390 seconds



### Note:

- All information shown herein is current as of the revision and publication date. Please refer
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# **REVISION CHANGE LIST**

**Document Title:** OV7670 Datasheet **Version:** 1.0

# **DESCRIPTION OF CHANGES**

**Initial Release** 



# **REVISION CHANGE LIST**

**Document Title:** OV7670 Datasheet **Version:** 1.01

# **DESCRIPTION OF CHANGES**

The following changes were made to version 1.0:

• Under LED and Strobe Flash Control Output section on page 3, changed text from "Refer to the OmniVision Technologies LED Strobe Support document" to "The OV7670 has a Strobe mode that allows it to work with an external flash and LED"